

MIC49150

1.5A Low Voltage LDO Regulator w/Dual Input Voltages

Features

- Input Voltage Range:
 - V_{IN}: 1.4V to 6.5V
 - V_{BIAS}: 3.0V to 6.5V
- Stable with 1 µF Ceramic Capacitor
- ±1% Initial Tolerance
- Maximum Dropout Voltage (V_{IN}-V_{OUT}) of 500 mV over Temperature
- Adjustable Output Voltage down to 0.9V
- Ultra Fast Transient Response (up to 10 MHz Bandwidth)
- Excellent Line and Load Regulation Specifications
- Logic Controlled Shutdown Option
- Thermal Shutdown and Current Limit Protection
- Power MSOP-8 and S-Pak Packages
- Junction Temperature Range: –40°C to +125°C

Applications

- Graphics Processors
- PC Add-in Cards
- Microprocessor Core Voltage Supply
- Low Voltage Digital ICs
- High Efficiency Linear Power Supplies
- SMPS Post Regulators

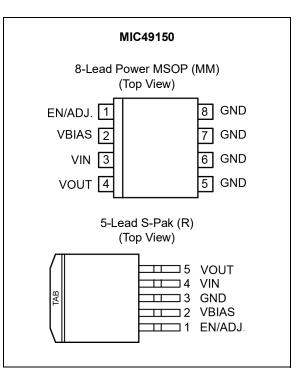
General Description

The MIC49150 is a high-bandwidth, low-dropout, 1.5A voltage regulator ideal for powering core voltages of low-power microprocessors. The MIC49150 implements a dual supply configuration allowing for very low output impedance and very fast transient response.

The MIC49150 requires a bias input supply and a main input supply, allowing for ultra-low input voltages on the main supply rail. The input supply operates from 1.4V to 6.5V and the bias supply requires between 3V and 6.5V for proper operation. The MIC49150 offers fixed output voltages from 0.9V to 1.8V and adjustable output voltages down to 0.9V.

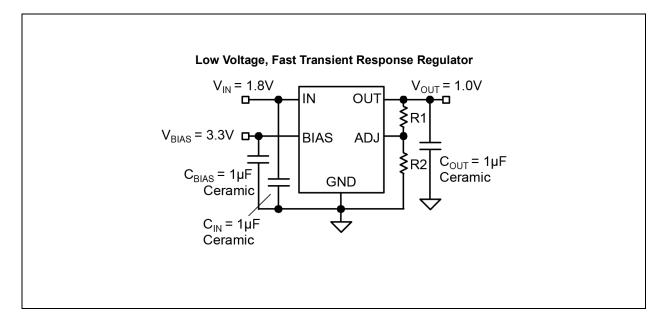
The MIC49150 requires a minimum of output capacitance for stability, working optimally with small ceramic capacitors.

The MIC49150 is available in an 8-lead power MSOP package and a 5-lead S-Pak. Its operating temperature range is -40° C to $+125^{\circ}$ C.

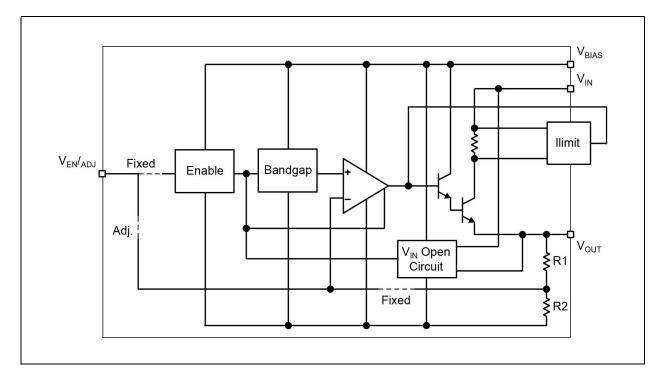


Package Types

Typical Application Circuit



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Voltage (V _{IN})	+8V
Bias Supply Voltage (V _{BIAS})	
Enable Input Voltage (V _{FN})	+8V
Power Dissipation	
ESD Rating, Note 1	

Operating Ratings ‡

Supply Voltage (V _{IN}).	+1.4V to +6.5V
Bias Supply Voltage (V _{BIAS})	+3V to +6.5V
Enable Input Voltage (V _{EN})	0V to +6.5V

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ Notice: The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD sensitive. Handling precautions recommended. Human body model, $1.5 \text{ k}\Omega$ in series with 100 pF.

ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$ with $V_{BIAS} = V_{OUT} + 2.1V$; $V_{IN} = V_{OUT} + 1V$; **bold** values indicate $-40^{\circ}C < T_J < +125^{\circ}C$, unless noted (Note 1)

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
	N	-1		+1	%	At 25°C
Output Voltage Accuracy	V _{OUT}	-2	_	+2	%	Over temperature range
Line Regulation	ΔV _{OUT} /V _{OUT}	-0.1	0.01	+0.1	%/V	$V_{IN} = V_{OUT} + 1V$ to 6.5V
Load Regulation		—	0.2	1	%	L = 0 mA to 1.50
	ΔV _{OUT} /V _{OUT}	—		1.5	%	I _L = 0 mA to 1.5A
		—	130	200	mV	IL = 750 mA
Dropout Voltago		—	_	300	mV	
Dropout Voltage	(V _{IN} – V _{OUT})	—	280	400	mV	- IL = 1.5A
		—		500	mV	1L - 1.3A
	(V _{BIAS} – V _{OUT})	—	1.3	_	V	IL = 750 mA
Dropout Voltage, Note 2		_	1.65	1.9	V	IL = 1.5A
		—		2.1	V	IL = 1.5A
	I _{GND}	—	15		mA	IL = 0 mA
Ground Pin Current, Note 3		_	15	25	mA	IL = 1.5A
		—		30	mA	IL = 1.5A
Ground Pin Current in	1	—	0.5	1	μA	$V_{EN} \le 0.6V$, $(I_{BIAS} + I_{CC})$,
Shutdown	I _{GND} (SHDN)	_		2	μA	Note 4
			9	15	mA	IL = 0 mA
Current through V _{BIAS}	I _{BIAS}	—		25	mA	IL = 0 mA
		—	32	_	mA	IL = 1.5A
Current Limit		1.6	2.3	3.4	А	
	I _{LIM}	_	_	4	А	

ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$ with $V_{BIAS} = V_{OUT} + 2.1V$; $V_{IN} = V_{OUT} + 1V$; **bold** values indicate $-40^{\circ}C < T_J < +125^{\circ}C$, unless noted (Note 1)

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Enable Input (Note 4)								
Enable Input Threshold	V _{IH}	1.6	_	_	V	Regulator enable		
(Fixed Voltage only)	V _{IL}	—	_	0.6	V	Regulator shutdown		
Enable Pin Input Current	I _{IN}	—	0.1	1	μA	Independent of state		
Reference								
Reference Voltage	V	0.891	0.9	0.909	V	—		
	V _{REF}	0.882	_	0.918	V	—		

Note 1: Specification for packaged product only.

2: For $V_{OUT} \le 1V$, V_{BIAS} dropout specification does not apply due to a minimum 3V V_{BIAS} input.

- **3:** $I_{GND} = I_{BIAS} + (I_{IN} I_{OUT})$. At high loads, input current on V_{IN} will be less than the output current, due to drive current being supplied by V_{BIAS} .
- 4: Fixed output voltage versions only.

TEMPERATURE SPECIFICATIONS (Note 1)

	· · ·								
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions			
Temperature Ranges									
Junction Temperature Range	TJ	-40	_	+125	°C	—			
Lead Temperature	_	_		+260	°C	—			
Storage Temperature	Τ _S	-65	—	+150	°C	—			
Package Thermal Resistance									
Thermal Resistance, MSOP-8	θ _{JA}	_	80	_	°C/W	—			
Thermal Resistance, S-Pak	θ _{JC}	_	2	—	°C/W	—			

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum rating. Sustained junction temperatures above that maximum can impact device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

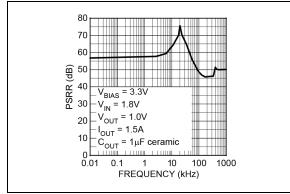


FIGURE 2-1: Power Supply Rejection Ratio (Input Supply).

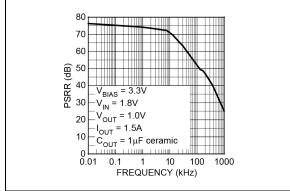
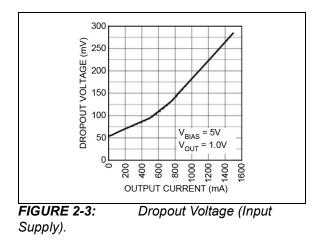


FIGURE 2-2: Power Supply Rejection Ratio (Bias Supply).



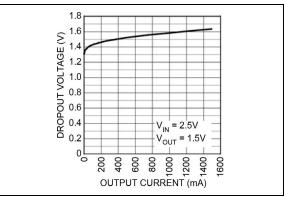
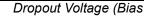


FIGURE 2-4: Supply).



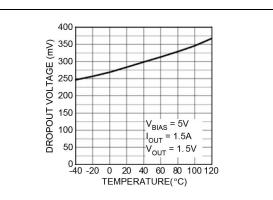


FIGURE 2-5: Dropout Voltage vs. Temperature (Input Supply).

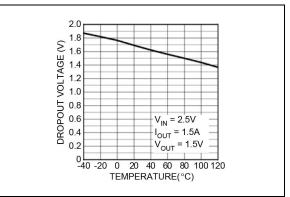


FIGURE 2-6:Dropout Voltage vs.Temperature (Bias Supply).

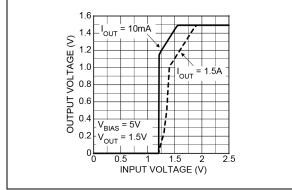


FIGURE 2-7: Dropout Characteristics (Input Voltage).

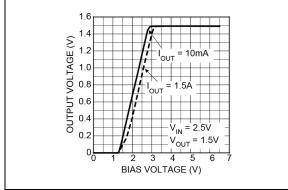


FIGURE 2-8: (Bias Voltage).

: Dropout Characteristics

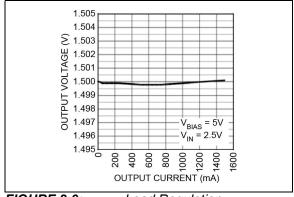


FIGURE 2-9:

Load Regulation.

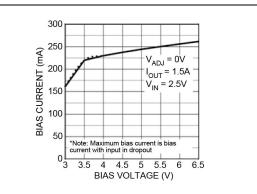


FIGURE 2-10: Maximum Bias Current vs. Bias Voltage.

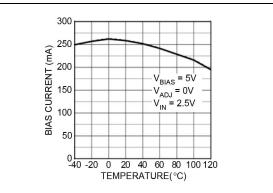


FIGURE 2-11: Maximum Bias Current vs. Temperature.

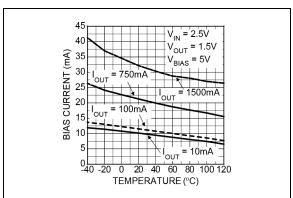


FIGURE 2-12: Bias Current vs. Temperature.

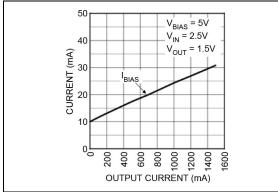


FIGURE 2-13: Bias Current vs. Output Current.

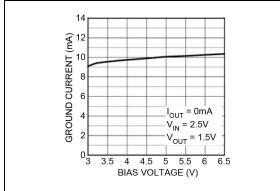
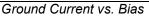


FIGURE 2-14: Gro Voltage.



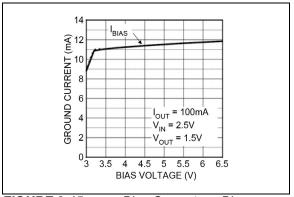


FIGURE 2-15: Bias Current vs. Bias Voltage.

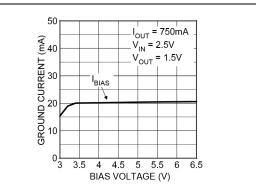


FIGURE 2-16: Voltage.

Bias Current vs. Bias

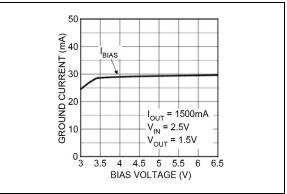


FIGURE 2-17: Bias Current vs. Bias Voltage.

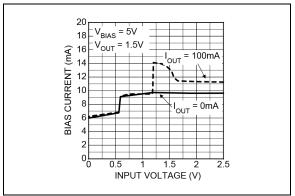


FIGURE 2-18: Bias Current vs. Input Voltage.

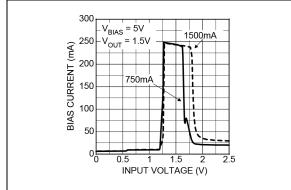


FIGURE 2-19: Bias Current vs. Input Voltage.

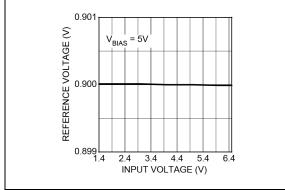


FIGURE 2-20: Reference Voltage vs. Input Voltage.

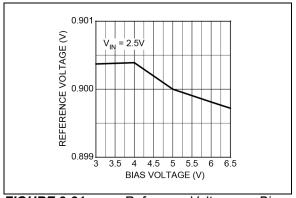


FIGURE 2-21: Reference Voltage vs. Bias Voltage.

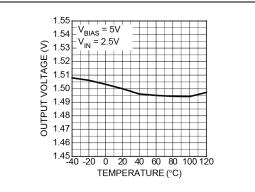


FIGURE 2-22: Output Voltage vs. Temperature.

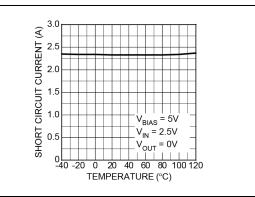


FIGURE 2-23: Short-Circuit Current vs. Temperature.

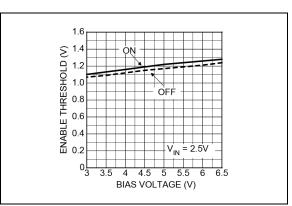


FIGURE 2-24: Enable Threshold vs. Bias Voltage.

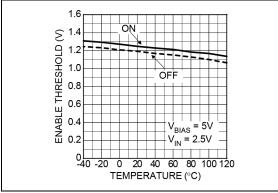
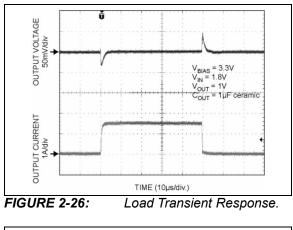
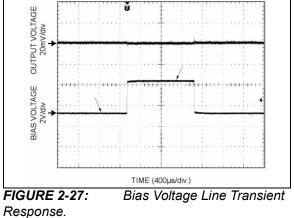


FIGURE 2-25: Enable Threshold vs. Temperature.





Bellow the second seco

FIGURE 2-28: Input Voltage Line Transient Response.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

Pin Number MSOP-8	Pin Number S-Pak	Pin Name	Description				
1	1	EN	Enable (Input): CMOS compatible input. Logic high = enable, logic low = shutdown.				
		ADJ	Adjustable Regulator Feedback Input. Connect to resistor voltage divider.				
2	2	VBIAS	Input Bias Voltage. Powers all circuitry on the regulator, with the exception of the output power device.				
3	4	VIN	Input Voltage. Supplies current to the output power device.				
4	5	OUT	Regulator Output.				
5, 6, 7, 8	3	GND	Ground (TAB is connected to ground on S-Pak).				

TABLE 3-1:PIN FUNCTION TABLE

4.0 APPLICATION INFORMATION

The MIC49150 is an ultra-high performance, low-dropout linear regulator designed for high current applications requiring fast transient response. The MIC49150 utilizes two input supplies, significantly reducing dropout voltage, perfect for low-voltage, DC-to-DC conversion. The MIC49150 requires a minimum of external components and obtains a bandwidth of up to 10 MHz. As a μ Cap regulator, the output is tolerant of virtually any type of capacitor including ceramic type and tantalum type capacitors.

The MIC49150 regulator is fully protected from damage due to fault conditions, offering linear current limiting and thermal shutdown.

4.1 Bias Supply Voltage

 V_{BIAS} , requiring relatively light current, provides power to the control portion of the MIC49150. V_{BIAS} requires approximately 33 mA for a 1.5A load current. Dropout conditions require higher currents. Most of the biasing current is used to supply the base current to the pass transistor. This allows the pass element to be driven into saturation, reducing the dropout to 300 mV at a 1.5A load current. Bypassing on the bias pin is recommended to improve performance of the regulator during line and load transients.

Small ceramic capacitors from V_{BIAS} to ground help reduce high frequency noise from being injected into the control circuitry from the bias rail and are good design practice. Good bypass techniques typically include one larger capacitor such as 1 μ F ceramic and smaller valued capacitors such as 0.01 μ F or 0.001 μ F in parallel with that larger capacitor to decouple the bias supply. The V_{BIAS} input voltage must be 1.6V above the output voltage with a minimum V_{BIAS} input voltage of 3V.

4.2 Input Supply Voltage

V_{IN} provides the high current to the collector of the pass transistor. The minimum input voltage is 1.4V, allowing conversion from low-voltage supplies.

4.3 Output Capacitor

The MIC49150 requires a minimum of output capacitance to maintain stability. However, proper capacitor selection is important to ensure desired transient response. The MIC49150 is specifically designed to be stable with virtually any capacitance value and ESR. A 1 μ F ceramic chip capacitor should satisfy most applications. Output capacitance can be increased without bound. See Typical Performance Curves for examples of load transient response.

X7R dielectric ceramic capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60% respectively over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic or a tantalum capacitor to ensure the same capacitance value over the operating temperature range. Tantalum capacitors have a very stable dielectric (10% over their operating temperature range) and can also be used with this device.

4.4 Input Capacitor

An input capacitor of 1 μ F or greater is recommended when the device is more than 4 inches away from the bulk supply capacitance, or when the supply is a battery. Small, surface-mount, ceramic chip capacitors can be used for the bypassing. The capacitor should be placed within 1 inch of the device for optimal performance. Larger values will help to improve ripple rejection by bypassing the input to the regulator, further improving the integrity of the output voltage.

4.5 Thermal Design

Linear regulators are simple to use. The most complicated design parameters to consider are thermal characteristics. Thermal design requires the following application-specific parameters:

- Maximum Ambient Temperature (T_A)
- Output Current (I_{OUT})
- Output Voltage (V_{OUT})
- Input Voltage (V_{IN})
- Ground Current (I_{GND})

First, calculate the power dissipation of the regulator from these numbers and the device parameters from this data sheet.

EQUATION 4-1:

$$P_D = V_{IN} \times I_{IN} + V_{BIAS} \times I_{BIAS} - V_{OUT} \times I_{OUT}$$

The input current will be less than the output current at high output currents as the load increases. The bias current is a sum of base drive and ground current. Ground current is constant over load current. Then the heat sink thermal resistance is determined with this formula:

© 2021 Microchip Technology Inc.

EQUATION 4-2:

$$\theta_{SA} = \left(\frac{T_{J(MAX)} - T_A}{P_D}\right) - (\theta_{JC} + \theta_{CS})$$

The heat sink may be significantly reduced in applications where the maximum input voltage is known and large compared with the dropout voltage. Use a series input resistor to drop excessive voltage and distribute the heat between this resistor and the regulator. The low-dropout properties of the MIC49150 allow significant reductions in regulator power dissipation and the associated heat sink without compromising performance. When this technique is employed, a input and regulator ground.

4.6 Minimum Load Current

The MIC49150, unlike most other high current regulators, does not require a minimum load to maintain output voltage regulation.

4.7 Power MSOP-8 Thermal Characteristics

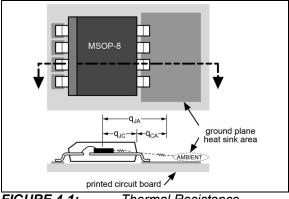
One of the secrets of the MIC49150's performance is its power MSOP-8 package featuring half the thermal resistance of a standard MSOP-8 package. Lower thermal resistance means more output current or higher input voltage for a given package size.

Lower thermal resistance is achieved by joining the four ground leads with the die attach paddle to create a single-piece electrical and thermal conductor. This concept has been used by MOSFET manufacturers for years, proving very reliable and cost effective for the user.

Thermal resistance consists of two main elements, θ_{JC} (junction-to-case thermal resistance) and θ_{CA} (case-toambient thermal resistance). See Figure 4-1. θ_{JC} is the resistance from the die to the leads of the package. θ_{CA} is the resistance from the leads to the ambient air and it includes θ_{CS} (case-to-sink thermal resistance) and θ_{SA} (sink-to-ambient thermal resistance).

Using the power MSOP-8 reduces the θ_{JC} dramatically and allows the user to reduce θ_{CA} . The total thermal resistance, θ_{JA} (junction-to-ambient thermal resistance) is the limiting factor in calculating the maximum power dissipation capability of the device. Typically, the power MSOP-8 has a θ_{JA} of 80°C/W, this is significantly lower than the standard MSOP-8 which is typically 160°C/W. θ_{CA} is reduced because Pins 5 through 8 can now be soldered directly to a ground plane which significantly reduces the case-to-sink thermal resistance and sink to ambient thermal resistance.

Low-dropout linear regulators from Microchip are rated to a maximum junction temperature of 125°C. It is important not to exceed this maximum junction temperature during operation of the device. To prevent this maximum junction temperature from being exceeded, the appropriate ground plane heat sink must be used.



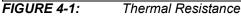


Figure 4-2 shows copper area versus power dissipation with each trace corresponding to a different temperature rise above ambient.

From these curves, the minimum area of copper necessary for the part to operate safely can be determined. The maximum allowable temperature rise must be calculated to determine operation along which curve.

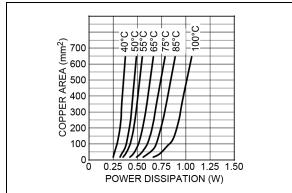


FIGURE 4-2: Copper Area vs. Power-MSOP Power Dissipation (ΔT_{JA})

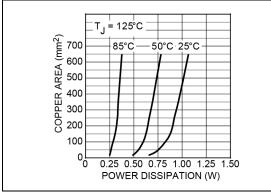


FIGURE 4-3: Copper Area vs. Power-MSOP Power Dissipation (T_A)

EQUATION 4-3:

$$\Delta T = T_{J(MAX)} - T_{A(MAX)}$$

Where:

 $T_{J(MAX)} = 125^{\circ}C$

T_{A(MAX)} = Maximum ambient operating temperature

For example, the maximum ambient temperature is 50°C, the Δ T is determined as follows:

EQUATION 4-4:

$$\Delta T = 125^{\circ}C - 50^{\circ}C = 75^{\circ}C$$

Using Figure 4-2, the minimum amount of required copper can be determined based on the required power dissipation. Power dissipation in a linear regulator is calculated as follows:

EQUATION 4-5:

$$P_D = V_{IN} \times I_{IN} + V_{BIAS} \times I_{BIAS} - V_{OUT} \times I_{OUT}$$

Using a typical application of 750 mA output current, 1.2V output voltage, 1.8V input voltage and 3.3V bias voltage, the power dissipation is as follows:

EQUATION 4-6:

$$P_D = 1.8V(730mA) + 3.3V(30mA) - 1.2V(750mA)$$

At full current, a small percentage of the output current is supplied from the bias supply, therefore the input current is less than the output current.

EQUATION 4-7:

$$P_D = 513 mW$$

From Figure 4-2, the minimum current of copper required to operate this application at a ΔT of 75°C is less than 100 mm².

4.8 Quick Method

Determine the power dissipation requirements for the design along with the maximum ambient temperature at which the device will be operated. Refer to Figure 4-3, which shows safe operating curves for three different ambient temperatures: 25°C, 50°C, and 85°C. From these curves, the minimum amount of copper can be determined by knowing the maximum power dissipation required. If the maximum ambient temperature is 50°C and the power dissipation is as above, 513 mW, the curve in Figure 4-3 shows that the required area of copper is less than 100 mm².

The θ_{JA} of this package is ideally 80°C/W, but it will vary depending upon the availability of copper ground plane to which it is attached.

4.9 Adjustable Regulator Design

The MIC49150 adjustable version allows programming the output voltage anywhere between 0.9V and 5V. Two resistors are used. The resistor value between V_{OUT} and the adjust pin should not exceed 10 k Ω . Larger values can cause instability. The resistor values are calculated by:

EQUATION 4-8:

$$R1 = R2 \times \left(\frac{V_{OUT}}{0.9} - 1\right)$$

Where:

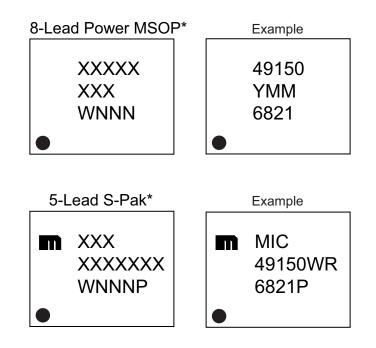
V_{OUT} is the output voltage.

4.10 Enable

The fixed output voltage versions of the MIC49150 feature an active-high enable input (EN) that allows on/off control of the regulator. Current drain reduces to "zero" when the device is shutdown, with only microamperes of leakage current. The EN input has TTL/CMOS compatible thresholds for simple logic interfacing. EN may be directly tied to V_{IN} and pulled up to the maximum supply voltage.

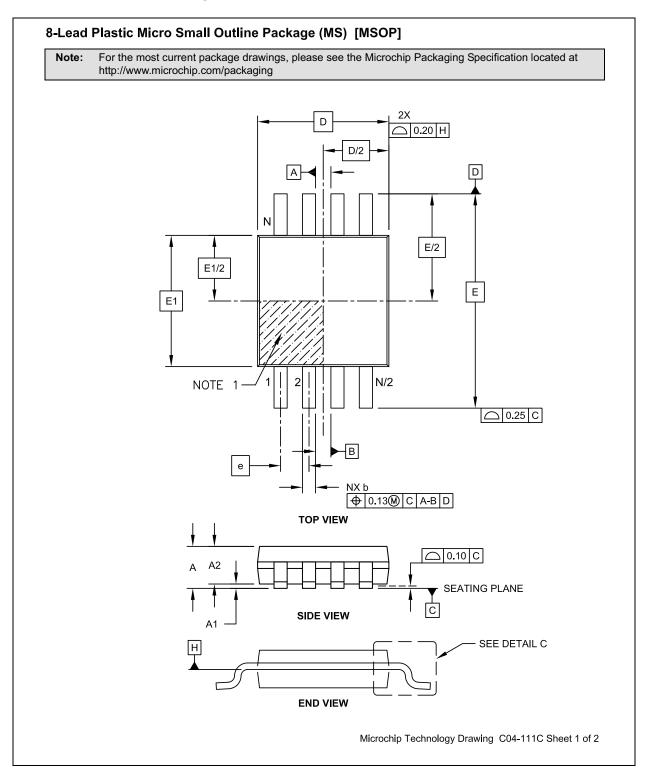
5.0 PACKAGING INFORMATION

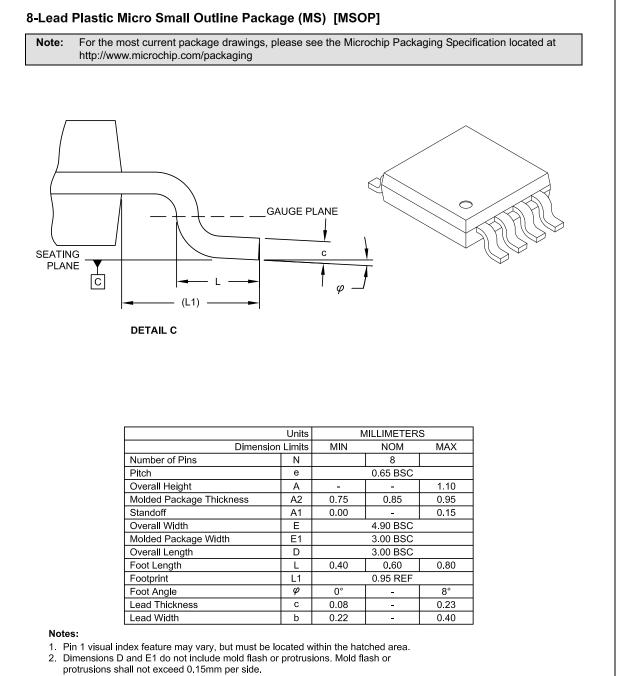
5.1 Package Marking Information



Y YY WW NNN @3 *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
be carried characters the corpor	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo. (_) and/or Overbar (⁻) symbol may not be to scale.
	Y YY WW NNN @3 * •, ▲, ▼ mark). In the even be carried characters the corpor

8-Lead Power MSOP Package Outline and Recommended Land Pattern



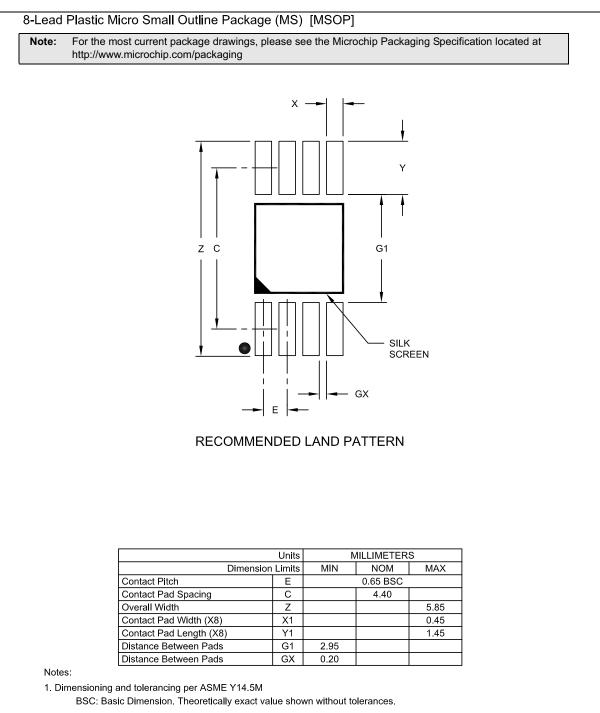


protrusions shall not exceed 0.15mm per side.
 Dimensioning and tolerancing per ASME Y14.5M.

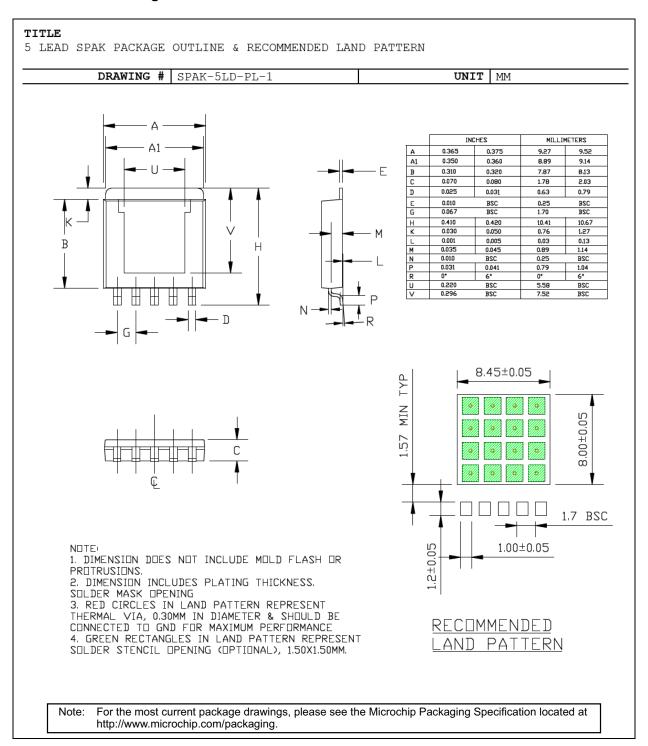
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-111C Sheet 2 of 2



Microchip Technology Drawing No. C04-2111A



5-Lead S-Pak Package Outline and Recommended Land Pattern

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (September 2021)

- Converted Micrel document MIC49150 to Microchip data sheet DS20006585A.
- Minor text changes throughout.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART No.	-X.X	x	xx	-XX	Exa	amples:	
Device	Output Voltage	Junction Temp. Range	Package	Media Type	a)	MIC49150-1.8WR:	MIC49150, 1.8V Output Voltage, -40°C to +125°C Temp. Range, 5-Lead S-Pak, 48/Tube
Device:	MIC49150): 1.5A Low \ Input Volta = Adjustable	/oltage LDO Regu ges	ılator w/Dual	b)	MIC49150-0.9YMM:	MIC49150, 0.9V Output Voltage, -40°C to +125°C Temp. Range, 8-Lead Power MSOP, 100/Tube
Output Voltage:	-0.9 = -1.2 = -1.5 =				c)	MIC49150-1.2WR-TR:	MIC49150, 1.2V Output Voltage, -40°C to +125°C Temp. Range, 5-Lead S-Pak, 750/Reel
Junction Temperature Range:	Y = W =	–40°C to +125°C –40°C to +125°C	(MM option only) (R option only)		d)	MIC49150-1.5YMM-TR	: MIC49150, 1.5V Output Voltage, -40°C to +125°C Temp. Range, 8-Lead Power MSOP, 2500/Reel
Package:	MM = R =	8-Lead Power M 5-Lead S-Pak	SOP		e)	MIC49150WR:	MIC49150, ADJ. Output Voltage, -40°C to +125°C Temp. Range, 5-Lead S-Pak 48/Tube
Media Type:	<blank> <blank> -TR = -TR =</blank></blank>	= 100/Tube (MM 750/Reel (R opti	option only) on only)		Note	catalog part numb used for ordering the device packag	entifier only appears in the per description. This identifier is purposes and is not printed on ge. Check with your Microchip ackage availability with the tion.

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods being used in attempts to breach the code protection features of the Microchip devices. We believe that these methods require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Attempts to breach these code protection features, most likely, cannot be accomplished without violating Microchip's intellectual property rights.
- Microchip is willing to work with any customer who is concerned about the integrity of its code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not
 mean that we are guaranteeing the product is "unbreakable." Code protection is constantly evolving. We at Microchip are
 committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection
 feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or
 other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication is provided for the sole purpose of designing with and using Microchip products. Information regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WAR-RANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDI-RECT, SPECIAL, PUNITIVE, INCIDENTAL OR CONSEQUEN-TIAL LOSS, DAMAGE, COST OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PackeTime, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, FlashTec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, IdealBridge, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, Inter-Chip Connectivity, JitterBlocker, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SMART-I.S., storClad, SQI, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, TSHARC, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries

 $\ensuremath{\mathsf{SQTP}}$ is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2021, Microchip Technology Incorporated, All Rights Reserved.

ISBN: 978-1-5224-8916-0

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

Canada - Toronto Tel: 905-695-1980 Fax: 905-695-2078

ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

China - Beijing Tel: 86-10-8569-7000 China - Chengdu

Tel: 86-28-8665-5511 China - Chongqing Tel: 86-23-8980-9588

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

China - Shenyang Tel: 86-24-2334-2829

China - Shenzhen Tel: 86-755-8864-2200

China - Suzhou Tel: 86-186-6233-1526

China - Wuhan Tel: 86-27-5980-5300

China - Xian Tel: 86-29-8833-7252

China - Xiamen Tel: 86-592-2388138 China - Zhuhai

Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631 India - Pune

Tel: 91-20-4121-0141 Japan - Osaka

Tel: 81-6-6152-7160

Japan - Tokyo Tel: 81-3-6880- 3770 Korea - Daegu

Tel: 82-53-744-4301 Korea - Seoul

Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

Singapore Tel: 65-6334-8870

Taiwan - Hsin Chu

Tel: 886-3-577-8366 Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100 Fax: 45-4485-2829 **Finland - Espoo** Tel: 358-9-4520-820

> France - Paris Tel: 33-1-69-53-63-20

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Tel: 45-4485-5910

Fax: 43-7242-2244-393

Denmark - Copenhagen

Fax: 33-1-69-30-90-79 Germany - Garching Tel: 49-8931-9700

Germany - Haan Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-72400

Germany - Karlsruhe Tel: 49-721-625370

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Rosenheim Tel: 49-8031-354-560

Israel - Ra'anana Tel: 972-9-744-7705

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Padova Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7288-4388

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820